

# LP3985 Micropower, 150mA Low-Noise Ultra Low-Dropout CMOS Voltage Regulator

Check for Samples: [LP3985](#)

## FEATURES

- Miniature 5-I/O micro SMD and SOT-23-5 package
- Logic controlled enable
- Stable with ceramic and high quality tantalum capacitors
- Fast turn-on
- Thermal shutdown and short-circuit current

limit

## APPLICATIONS

- CDMA cellular handsets
- Wideband CDMA cellular handsets
- GSM cellular handsets
- Portable information appliances

## DESCRIPTION

The LP3985 is designed for portable and wireless applications with demanding performance and space requirements.

The LP3985 is stable with a small  $1\mu\text{F} \pm 30\%$  ceramic or high-quality tantalum output capacitor. The micro SMD requires the smallest possible PC board area - the total application circuit area can be less than  $2.0\text{mm} \times 2.5\text{mm}$ , a fraction of a 1206 case size.

The LP3985's performance is optimized for battery powered systems to deliver ultra low noise, extremely low dropout voltage and low quiescent current. Regulator ground current increases only slightly in dropout, further prolonging the battery life.

An optional external bypass capacitor reduces the output noise without slowing down the load transient response. Fast startup time is achieved by utilizing an internal power-on circuit that actively pre-charges the bypass capacitor.

Power supply rejection is better than 50dB at low frequencies and starts to roll off at 1kHz. High power supply rejection is maintained down to low input voltage levels common to battery operated circuits.

The device is ideal for mobile phone and similar battery powered wireless applications. It provides up to 150mA, from a 2.5V to 6V input. The LP3985 consumes less than  $1.5\mu\text{A}$  in disable mode and has fast turn-on time less than  $200\mu\text{s}$ .

The LP3985 is available in a 5-bump thin micro SMD and a 5-pin SOT-23 package. Performance is specified for  $-40^\circ\text{C}$  to  $+125^\circ\text{C}$  temperature range and is available in 2.5V, 2.6V, 2.7V, 2.8V, 2.85V, 2.9V, 3.0V, 3.1V, 3.2V, 3.3V, 4.7V, 4.75V, 4.8V and 5.0V output voltages. For other output voltage options between 2.5V to 5.0V or for a dual LP3985, please contact a Texas Instruments sales office.

**Table 1. Key Specifications**

	VALUE	UNIT
2.5 to 6.0V input range		
150mA guaranteed output		
50dB PSRR at 1kHz @ $V_{\text{IN}} = V_{\text{OUT}} + 0.2\text{V}$		
$\leq 1.5\mu\text{A}$ quiescent current when shut down		
Fast Turn-On time: $200\mu\text{s}$ (typ.)		
100mV maximum dropout with 150mA load		
$30\mu\text{V}_{\text{rms}}$ output noise (typ.) over 10Hz to 100kHz		
$-40$ to $+125^\circ\text{C}$ junction temperature range for operation		
2.5V, 2.6V, 2.7V, 2.8V, 2.85V, 2.9V, 3.0V, 3.1V, 3.2V, 3.3V, 4.7V, 4.75V, 4.8V and 5.0V outputs standard		



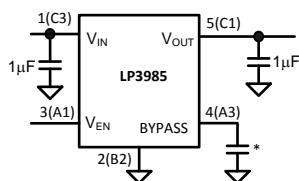
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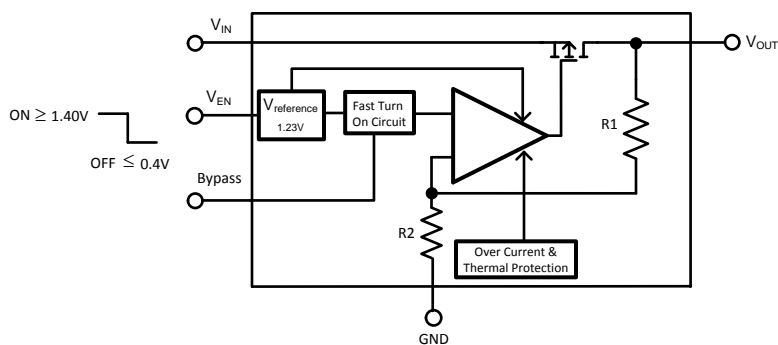
## Typical Application Circuit



Note: Pin Numbers in parenthesis indicate micro SMD package.

\* Optional Noise Reduction Capacitor.

## Block Diagram

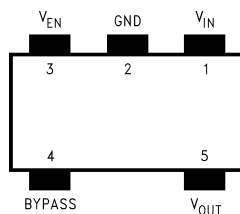


## Pin Functions

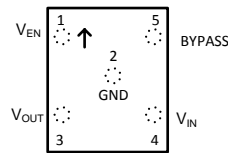
### Pin Descriptions

Name	* micro SMD	SOT	Function
V <sub>EN</sub>	A1	3	Enable Input Logic, Enable High
GND	B2	2	Common Ground
V <sub>OUT</sub>	C1	5	Output Voltage of the LDO
V <sub>IN</sub>	C3	1	Input Voltage of the LDO
BYPASS	A3	4	Optional Bypass Capacitor for Noise Reduction

## Connection Diagram



**Figure 1. Top View  
SOT 23-5 Package (MF)  
Package Number MF05A**



**Figure 2. Top View  
5-Bump micro SMD Package (TLA05)  
Package Number TLA05**



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### Absolute Maximum Ratings <sup>(1) (2)</sup>

$V_{IN}, V_{EN}$	-0.3 to 6.5V
$V_{OUT}$	-0.3 to $(V_{IN}+0.3) \leq 6.5V$
Junction Temperature	150°C
Storage Temperature	-65°C to +150°C
Lead Temp.	235°C
Pad Temp. <sup>(3)</sup>	235°C
Maximum Power Dissipation SOT23-5 <sup>(4)</sup> micro SMD <sup>(4)</sup>	364mW 314mW
ESD Rating <sup>(5)</sup> Human Body Model Machine Model	2kV 150V

- (1) Absolute Maximum Ratings are limits beyond which damage to the device may occur. Operating Ratings are conditions under which operation of the device is guaranteed. Operating Ratings do not imply guaranteed performance limits. For guaranteed performance limits and associated test conditions, see the Electrical Characteristics tables.
- (2) All voltages are with respect to the potential at the GND pin.
- (3) Additional information on lead temperature and pad temperature can be found in National Semiconductor Application Note (AN-1112).
- (4) The Absolute Maximum power dissipation depends on the ambient temperature and can be calculated using the formula:  $P_D = (T_J - T_A)/\theta_{JA}$ , where  $T_J$  is the junction temperature,  $T_A$  is the ambient temperature, and  $\theta_{JA}$  is the junction-to-ambient thermal resistance. The 364mW rating for SOT23-5 appearing under Absolute Maximum Ratings results from substituting the Absolute Maximum junction temperature, 150°C, for  $T_J$ , 70°C for  $T_A$ , and 220°C/W for  $\theta_{JA}$ . More power can be dissipated safely at ambient temperatures below 70°C. Less power can be dissipated safely at ambient temperatures above 70°C. The Absolute Maximum power dissipation can be increased by 4.5mW for each degree below 70°C, and it must be derated by 4.5mW for each degree above 70°C.
- (5) The human body model is 100pF discharged through 1.5kΩ resistor into each pin. The machine model is a 200 pF capacitor discharged directly into each pin.

### Operating Ratings <sup>(1) (2)</sup>

$V_{IN}$	2.5 to 6V
$V_{EN}$	0 to $(V_{IN}+0.3) \leq 6V$
Junction Temperature	-40°C to +125°C
Thermal Resistance $\theta_{JA}$ (SOT23-5) $\theta_{JA}$ (micro SMD)	220°C/W 255°C/W
Maximum Power Dissipation SOT23-5 <sup>(3)</sup> micro SMD <sup>(3)</sup>	250mW 216mW

- (1) Absolute Maximum Ratings are limits beyond which damage to the device may occur. Operating Ratings are conditions under which operation of the device is guaranteed. Operating Ratings do not imply guaranteed performance limits. For guaranteed performance limits and associated test conditions, see the Electrical Characteristics tables.
- (2) All voltages are with respect to the potential at the GND pin.
- (3) Like the Absolute Maximum power dissipation, the maximum power dissipation for operation depends on the ambient temperature. The 250mW rating for SOT23-5 appearing under Operating Ratings results from substituting the maximum junction temperature for operation, 125°C, for  $T_J$ , 70°C for  $T_A$ , and 220°C/W for  $\theta_{JA}$  into  $P_D = (T_J - T_A)/\theta_{JA}$  above. More power can be dissipated at ambient temperatures below 70°C. Less power can be dissipated at ambient temperatures above 70°C. The maximum power dissipation for operation can be increased by 4.5mW for each degree below 70°C, and it must be derated by 4.5mW for each degree above 70°C.

## Electrical Characteristics

Unless otherwise specified:  $V_{IN} = V_{OUT(nom)} + 0.5V$ ,  $C_{IN} = 1\ \mu F$ ,  $I_{OUT} = 1mA$ ,  $C_{OUT} = 1\ \mu F$ ,  $C_{BYPASS} = 0.01\ \mu F$ . Typical values and limits appearing in standard typeface are for  $T_J = 25^\circ C$ . Limits appearing in **boldface type** apply over the entire junction temperature range for operation,  $-40^\circ C$  to  $+125^\circ C$ . <sup>(1)</sup> <sup>(2)</sup>

Symbol	Parameter	Conditions	Typ	Limit		Units
				Min	Max	
$\Delta V_{OUT}$	Output Voltage Tolerance	$I_{OUT} = 1mA$		-2 -3	2 3	% of $V_{OUT(nom)}$
	Line Regulation Error	$V_{IN} = (V_{OUT(nom)} + 0.5V)$ to 6.0V, For 4.7 to 5.0 options For all other options		-0.19 -0.1	0.19 0.1	%/V
	Load Regulation Error <sup>(3)</sup>	$I_{OUT} = 1mA$ to 150 mA LP3985IM5 (SOT23-5)	0.0025		0.005	%/mA
		LP3985 (micro SMD)	0.0004		0.002	
	Output AC Line Regulation	$V_{IN} = V_{OUT(nom)} + 1V$ , $I_{OUT} = 150mA$ (Figure 3)	1.5			mV <sub>P-P</sub>
PSRR	Power Supply Rejection Ratio	$V_{IN} = V_{OUT(nom)} + 0.2V$ , $f = 1kHz$ , $I_{OUT} = 50mA$ (Figure 4)	50			dB
		$V_{IN} = V_{OUT(nom)} + 0.2V$ , $f = 10kHz$ , $I_{OUT} = 50mA$ (Figure 4)	40			
$I_Q$	Quiescent Current	$V_{EN} = 1.4V$ , $I_{OUT} = 0mA$ For 4.7 to 5.0 options For all other options	100 85		165 150	$\mu A$
		$V_{EN} = 1.4V$ , $I_{OUT} = 0$ to 150 mA For 4.7 to 5.0 options For all other options	155 140		250 200	
		$V_{EN} = 0.4V$	0.003		1.5	
	Dropout Voltage <sup>(4)</sup>	$I_{OUT} = 1mA$	0.4		2	mV
		$I_{OUT} = 50mA$	20		35	
		$I_{OUT} = 100mA$	45		70	
		$I_{OUT} = 150mA$	60		100	
$I_{SC}$	Short Circuit Current Limit	Output Grounded (Steady State)	600			mA
$I_{OUT(PK)}$	Peak Output Current	$V_{OUT} \geq V_{OUT(nom)} - 5\%$	550	300		mA
$T_{ON}$	Turn-On Time <sup>(5)</sup>	$C_{BYPASS} = 0.01\ \mu F$	200			$\mu s$
$e_n$	Output Noise Voltage <sup>(6)</sup>	BW = 10 Hz to 100 kHz, $C_{OUT} = 1\ \mu F$	30			$\mu V_{rms}$
	Output Noise Density	$C_{BP} = 0$	230			nV/ $\sqrt{Hz}$
$I_{EN}$	Maximum Input Current at EN	$V_{EN} = 0.4$ and $V_{IN} = 6.0$	$\pm 1$			nA
$V_{IL}$	Maximum Low Level Input Voltage at EN	$V_{IN} = 2.5$ to 6.0V			0.4	V
$V_{IH}$	Minimum High Level Input Voltage at EN	$V_{IN} = 2.5$ to 6.0V		1.4		V

- (1) All limits are guaranteed. All electrical characteristics having room-temperature limits are tested during production with  $T_J = 25^\circ C$  or correlated using Statistical Quality Control (SQC) methods. All hot and cold limits are guaranteed by correlating the electrical characteristics to process and temperature variations and applying statistical process control.
- (2) The target output voltage, which is labeled  $V_{OUT(nom)}$ , is the desired voltage option.
- (3) An increase in the load current results in a slight decrease in the output voltage and vice versa.
- (4) Dropout voltage is the input-to-output voltage difference at which the output voltage is 100mV below its nominal value. This specification does not apply for input voltages below 2.5V.
- (5) Turn-on time is time measured between the enable input just exceeding  $V_{IH}$  and the output voltage just reaching 95% of its nominal value.
- (6) The output noise varies with output voltage option. The 30 $\mu V_{rms}$  is measured with 2.5V voltage option. To calculate an approximated output noise for other options, use the equation: (30 $\mu V_{rms}$ )(X)/2.5, where X is the voltage option value.

## Electrical Characteristics (continued)

Unless otherwise specified:  $V_{IN} = V_{OUT(nom)} + 0.5V$ ,  $C_{IN} = 1\ \mu F$ ,  $I_{OUT} = 1mA$ ,  $C_{OUT} = 1\ \mu F$ ,  $C_{BYPASS} = 0.01\ \mu F$ . Typical values and limits appearing in standard typeface are for  $T_J = 25^\circ C$ . Limits appearing in **boldface type** apply over the entire junction temperature range for operation,  $-40^\circ C$  to  $+125^\circ C$ . <sup>(1)</sup> <sup>(2)</sup>

Symbol	Parameter	Conditions	Typ	Limit		Units
				Min	Max	
TSD	Thermal Shutdown Temperature		160			$^\circ C$
	Thermal Shutdown Hysteresis		20			$^\circ C$

## Recommended Output Capacitor

Symbol	Parameter	Conditions	Nominal Value	Limit		Units
				Min	Max	
$C_{OUT}$	Output Capacitor	Capacitance <sup>(1)</sup>	1.0	<b>0.7</b>		$\mu F$
		ESR		<b>5</b>	<b>500</b>	m $\Omega$

- (1) The minimum value of capacitance for stability and correct operation is  $0.7\ \mu F$ . The Capacitor tolerance should be  $\pm 30\%$  or better over the temperature range. The full range of operating conditions for the capacitor in the application should be considered during device selection to ensure this minimum capacitance specification is met. The recommended capacitor type is X7R to meet the full device temperature spec of  $-40^\circ C$  to  $125^\circ C$ . See the capacitor section in Application Hints.

## Timing Diagrams

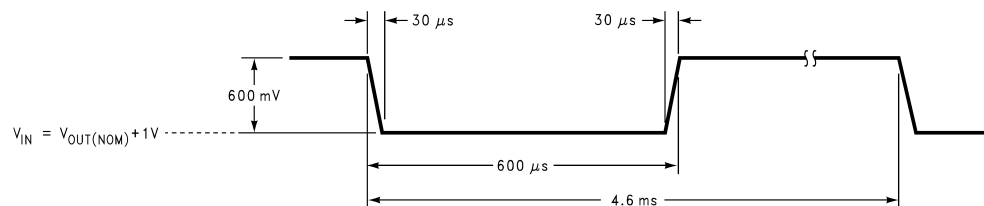


Figure 3. Line Transient Input Test Signal

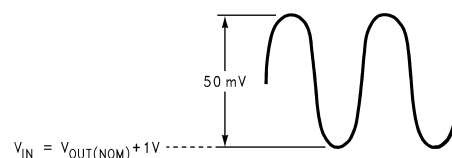
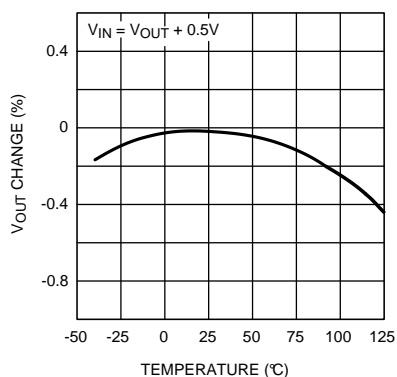


Figure 4. PSRR Input Test Signal

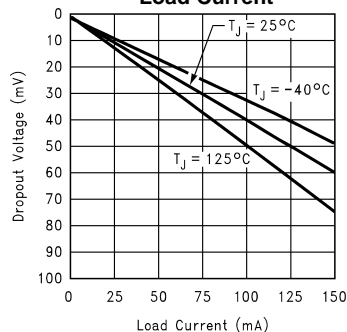
## Typical Performance Characteristics

Unless otherwise specified,  $C_{IN} = C_{OUT} = 1\ \mu\text{F}$  Ceramic,  $C_{BYPASS} = 0.01\ \mu\text{F}$ ,  $V_{IN} = V_{OUT} + 0.2\text{V}$ ,  $T_A = 25^\circ\text{C}$ , Enable pin is tied to  $V_{IN}$ .

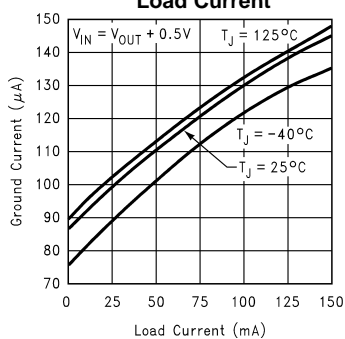
**Output Voltage Change  
vs  
Temperature**



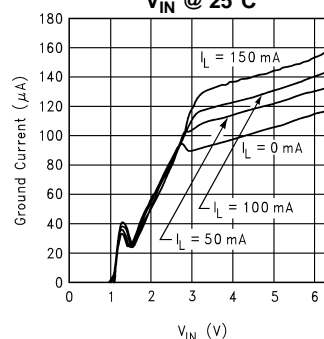
**Dropout Voltage  
vs  
Load Current**



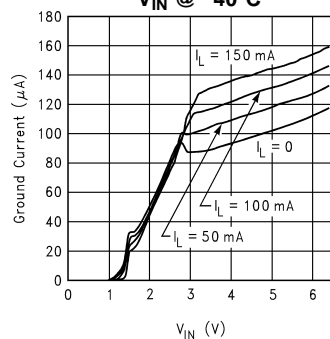
**Ground Current  
vs  
Load Current**



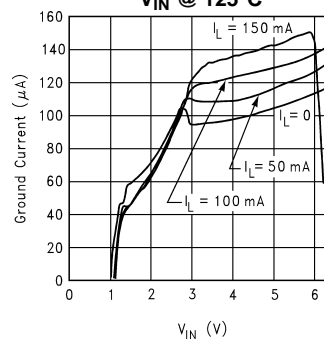
**Ground Current  
vs  
 $V_{IN}$  @ 25°C**



**Ground Current  
vs  
 $V_{IN}$  @ -40°C**



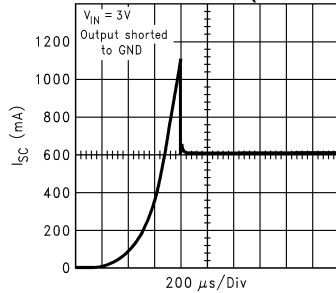
**Ground Current  
vs  
 $V_{IN}$  @ 125°C**



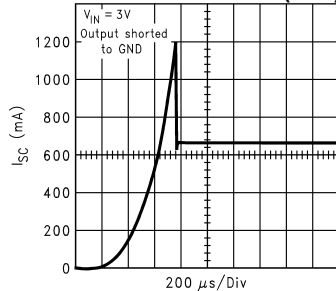
## Typical Performance Characteristics (continued)

Unless otherwise specified,  $C_{IN} = C_{OUT} = 1 \mu F$  Ceramic,  $C_{BYPASS} = 0.01 \mu F$ ,  $V_{IN} = V_{OUT} + 0.2V$ ,  $T_A = 25^\circ C$ , Enable pin is tied to  $V_{IN}$ .

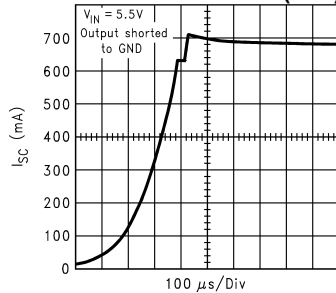
**Short Circuit Current (micro SMD)**



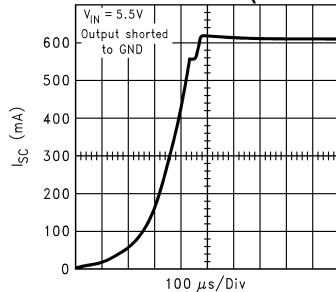
**Short Circuit Current (SOT)**



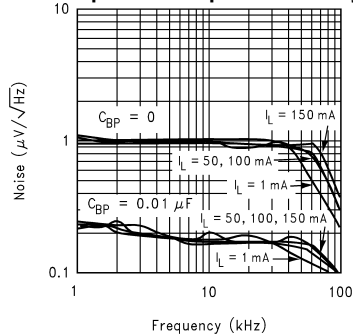
**Short Circuit Current (SOT)**



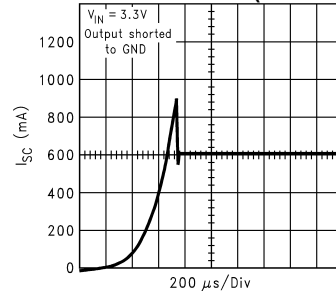
**Short Circuit Current (micro SMD)**



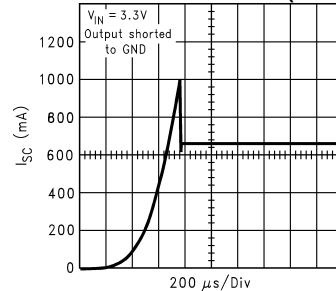
**Output Noise Spectral Density**



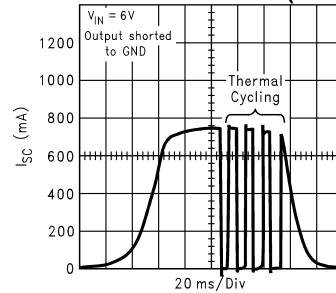
**Short Circuit Current (micro SMD)**



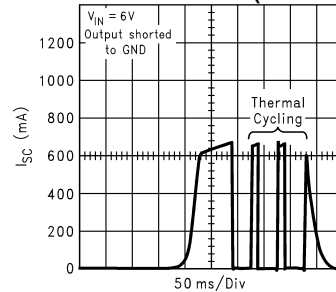
**Short Circuit Current (SOT)**



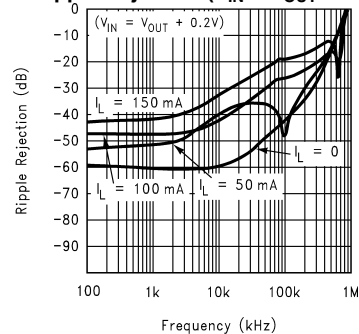
**Short Circuit Current (SOT)**



**Short Circuit Current (micro SMD)**

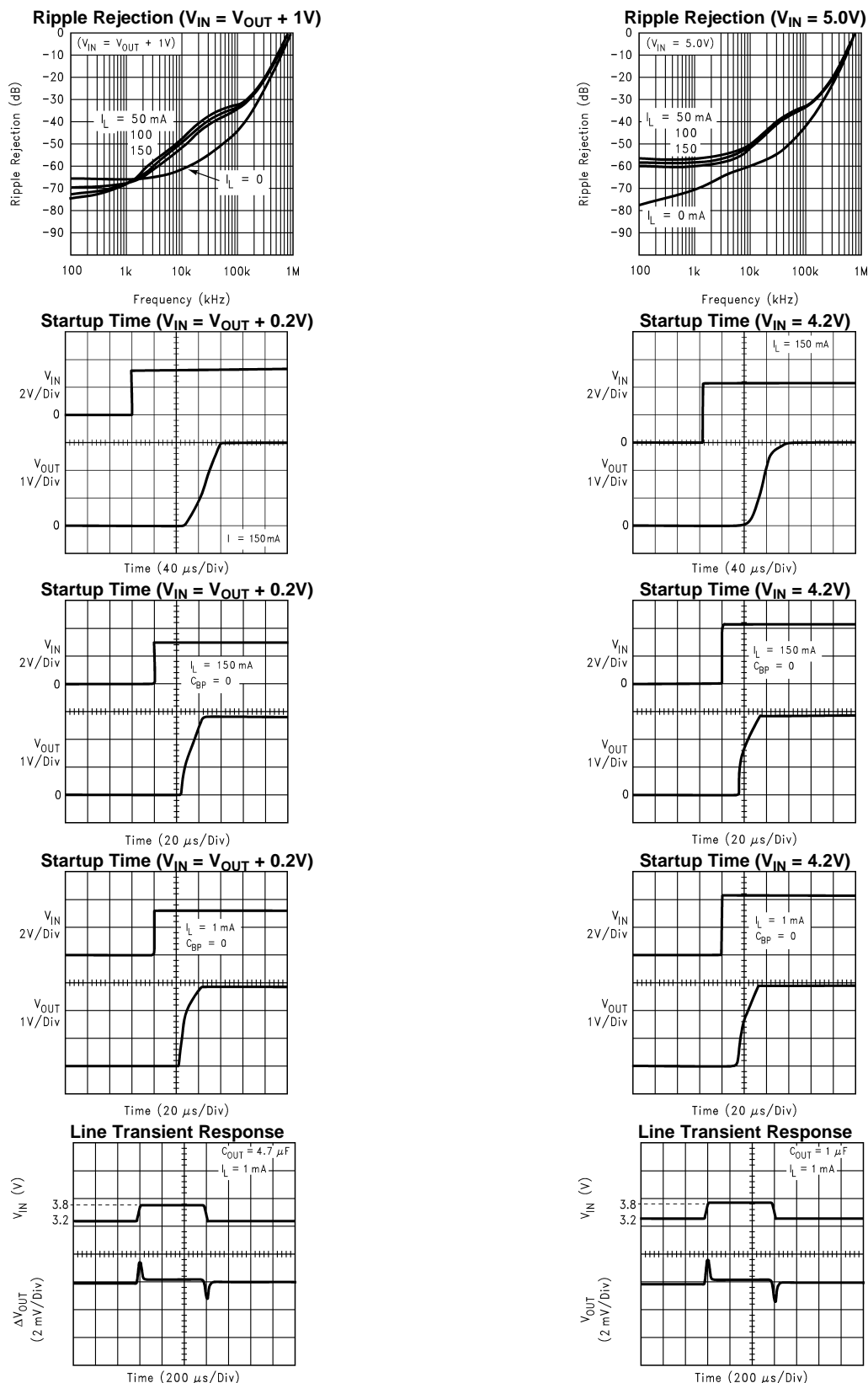


**Ripple Rejection ( $V_{IN} = V_{OUT} + 0.2V$ )**



## Typical Performance Characteristics (continued)

Unless otherwise specified,  $C_{IN} = C_{OUT} = 1\ \mu\text{F}$  Ceramic,  $C_{BYPASS} = 0.01\ \mu\text{F}$ ,  $V_{IN} = V_{OUT} + 0.2\text{V}$ ,  $T_A = 25^\circ\text{C}$ , Enable pin is tied to  $V_{IN}$ .

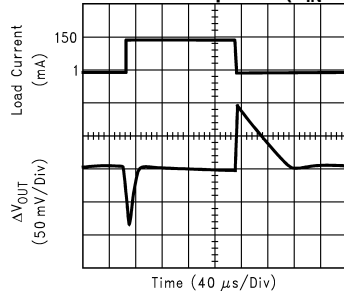




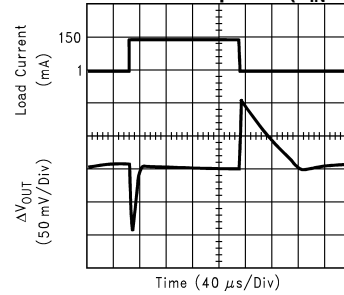
## Typical Performance Characteristics (continued)

Unless otherwise specified,  $C_{IN} = C_{OUT} = 1\ \mu\text{F}$  Ceramic,  $C_{BYPASS} = 0.01\ \mu\text{F}$ ,  $V_{IN} = V_{OUT} + 0.2\text{V}$ ,  $T_A = 25^\circ\text{C}$ , Enable pin is tied to  $V_{IN}$ .

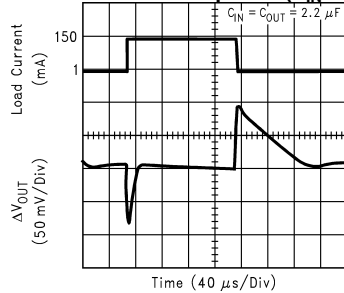
**Load Transient Response ( $V_{IN} = 3.2\text{V}$ )**



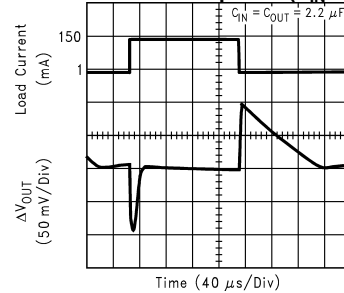
**Load Transient Response ( $V_{IN} = 4.2\text{V}$ )**



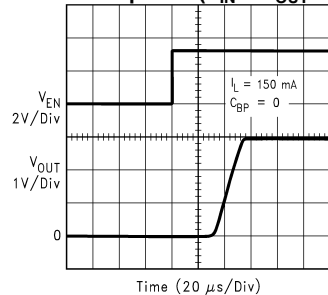
**Load Transient Response ( $V_{IN} = 3.2\text{V}$ )**



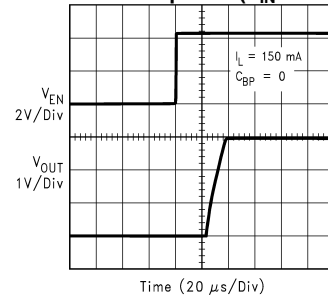
**Load Transient Response ( $V_{IN} = 4.2\text{V}$ )**



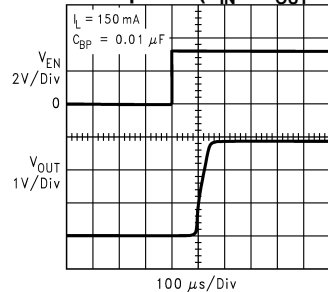
**Enable Response ( $V_{IN} = V_{OUT} + 0.2\text{V}$ )**



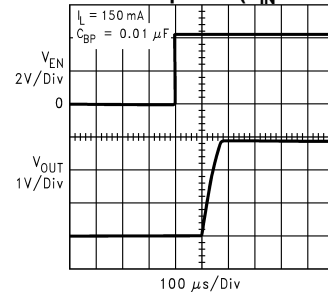
**Enable Response ( $V_{IN} = 4.2\text{V}$ )**



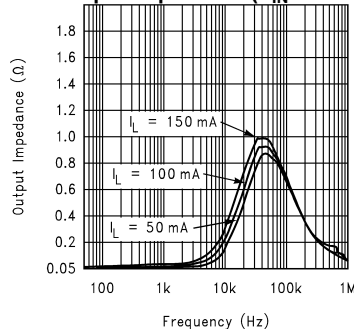
**Enable Response ( $V_{IN} = V_{OUT} + 0.2\text{V}$ )**



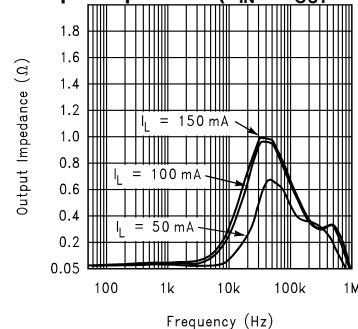
**Enable Response ( $V_{IN} = 4.2\text{V}$ )**



**Output Impedance ( $V_{IN} = 4.2\text{V}$ )**



**Output Impedance ( $V_{IN} = V_{OUT} + 0.2\text{V}$ )**



## Application Hints

### EXTERNAL CAPACITORS

Like any low-dropout regulator, the LP3985 requires external capacitors for regulator stability. The LP3985 is specifically designed for portable applications requiring minimum board space and smallest components. These capacitors must be correctly selected for good performance.

### INPUT CAPACITOR

An input capacitance of  $\approx 1\mu\text{F}$  is required between the LP3985 input pin and ground (the amount of the capacitance may be increased without limit).

This capacitor must be located a distance of not more than 1cm from the input pin and returned to a clean analog ground. A ceramic capacitor is recommended although a good quality tantalum or film capacitor may be used at the input.

**Important:** Tantalum capacitors can suffer catastrophic failures due to surge current when connected to a low-impedance source of power (like a battery or a very large capacitor). If a tantalum capacitor is used at the input, it must be guaranteed by the manufacturer to have a surge current rating sufficient for the application.

There are no requirements for the ESR on the input capacitor, but tolerance and temperature coefficient must be considered when selecting the capacitor to ensure the capacitance will remain within the operational range over the full range of temperature and operating conditions.

### OUTPUT CAPACITOR

Correct selection of the output capacitor is important to ensure stable operation in the intended application.

The output capacitor must meet all the requirements specified in the recommended capacitor table over all conditions in the application. These conditions include DC-bias, frequency and temperature. Unstable operation will result if the capacitance drops below the minimum specified value. (See the next section Capacitor Characteristics).

The LP3985 is designed specifically to work with very small ceramic output capacitors. A  $1.0\mu\text{F}$  ceramic capacitor (dielectric type X7R) with ESR between  $5\text{m}\Omega$  to  $500\text{m}\Omega$  is suitable in the LP3985 application circuit. X5R capacitors may be used but have a narrower temperature range. With these and other capacitor types (Y5V, Z6U) that may be used, selection is dependant on the range of operating conditions and temperature range for that application. (see section on Capacitor Characteristics).

It may also be possible to use tantalum or film capacitors at the output, but these are not as attractive for reasons of size and cost (see next section Capacitor Characteristics).

It is also recommended that the output capacitor be placed within 1cm from the output pin and returned to a clean ground line.

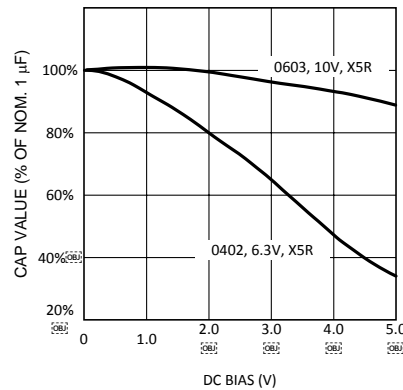
### CAPACITOR CHARACTERISTICS

The LP3985 is designed to work with ceramic capacitors on the output to take advantage of the benefits they offer: for capacitance values in the range of  $1\mu\text{F}$  to  $4.7\mu\text{F}$  range, ceramic capacitors are the smallest, least expensive and have the lowest ESR values (which makes them best for eliminating high frequency noise). The ESR of a typical  $1\mu\text{F}$  ceramic capacitor is in the range of  $20\text{m}\Omega$  to  $40\text{m}\Omega$ , which easily meets the ESR requirement for stability by the LP3985.

For both input and output capacitors careful interpretation of the capacitor specification is required to ensure correct device operation. The capacitor value can change greatly dependant on the conditions of operation and capacitor type.

In particular the output capacitor selection should take account of all the capacitor parameters to ensure that the specification is met within the application. Capacitance value can vary with DC bias conditions as well as temperature and frequency of operation. Capacitor values will also show some decrease over time due to aging. The capacitor parameters are also dependant on the particular case size with smaller sizes giving poorer performance figures in general. As an example [Figure 5](#) shows a typical graph showing a comparison of capacitor case sizes in a Capacitance vs. DC Bias plot. As shown in the graph, as a result of the DC Bias

condition the capacitance value may drop below the minimum capacitance value given in the recommended capacitor table (0.7 $\mu$ F in this case). Note that the graph shows the capacitance out of spec for the 0402 case size capacitor at higher bias voltages. It is therefore recommended that the capacitor manufacturers' specifications for the nominal value capacitor are consulted for all conditions as some capacitor sizes (e.g. 0402) may not be suitable in the actual application.



**Figure 5. Graph Showing A Typical Variation in Capacitance vs DC Bias**

The ceramic capacitor's capacitance can vary with temperature. The capacitor type X7R, which operates over a temperature range of  $-55^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ , will only vary the capacitance to within  $\pm 15\%$ . The capacitor type X5R has a similar tolerance over a reduced temperature range of  $-55^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ . Most large value ceramic capacitors ( $\approx 2.2\mu\text{F}$ ) are manufactured with Z5U or Y5V temperature characteristics. Their capacitance can drop by more than 50% as the temperature goes from  $25^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ . Therefore X7R is recommended over Z5U and Y5V in applications where the ambient temperature will change significantly above or below  $25^{\circ}\text{C}$ .

Tantalum capacitors are less desirable than ceramic for use as output capacitors because they are more expensive when comparing equivalent capacitance and voltage ratings in the  $1\mu\text{F}$  to  $4.7\mu\text{F}$  range.

Another important consideration is that tantalum capacitors have higher ESR values than equivalent size ceramics. This means that while it may be possible to find a tantalum capacitor with an ESR value within the stable range, it would have to be larger in capacitance (which means bigger and more costly) than a ceramic capacitor with the same ESR value. It should also be noted that the ESR of a typical tantalum will increase about 2:1 as the temperature goes from  $25^{\circ}\text{C}$  down to  $-40^{\circ}\text{C}$ , so some guard band must be allowed.

## NOISE BYPASS CAPACITOR

Connecting a  $0.01\mu\text{F}$  capacitor between the  $C_{\text{BYPASS}}$  pin and ground significantly reduces noise on the regulator output. This cap is connected directly to a high impedance node in the band gap reference circuit. Any significant loading on this node will cause a change on the regulated output voltage. For this reason, DC leakage current through this pin must be kept as low as possible for best output voltage accuracy.

The types of capacitors best suited for the noise bypass capacitor are ceramic and film. High-quality ceramic capacitors with either NPO or COG dielectric typically have very low leakage. Polypropylene and polycarbonate film capacitors are available in small surface-mount packages and typically have extremely low leakage current.

Unlike many other LDO's, addition of a noise reduction capacitor does not effect the load transient response of the device.

## NO-LOAD STABILITY

The LP3985 will remain stable and in regulation with no external load. This is specially important in CMOS RAM keep-alive applications.

## ON/OFF INPUT OPERATION

The LP3985 is turned off by pulling the  $V_{EN}$  pin low, and turned on by pulling it high. If this feature is not used, the  $V_{EN}$  pin should be tied to  $V_{IN}$  to keep the regulator output on at all time. To assure proper operation, the signal source used to drive the  $V_{EN}$  input must be able to swing above and below the specified turn-on/off voltage thresholds listed in the Electrical Characteristics section under  $V_{IL}$  and  $V_{IH}$ .

## FAST ON-TIME

The LP3985 output is turned on after  $V_{ref}$  voltage reaches its final value (1.23V nominal). To speed up this process, the noise reduction capacitor at the bypass pin is charged with an internal 70 $\mu$ A current source. The current source is turned off when the bandgap voltage reaches approximately 95% of its final value. The turn on time is determined by the time constant of the bypass capacitor. The smaller the capacitor value, the shorter the turn on time, but less noise gets reduced. As a result, turn on time and noise reduction need to be taken into design consideration when choosing the value of the bypass capacitor.

## micro SMD MOUNTING

The micro SMD package requires specific mounting techniques which are detailed in Texas Instruments Application Note (AN-1112). Referring to the section *Surface Mount Technology (SMT) Assembly Considerations*, it should be noted that the pad style which must be used with the 5-bump package is NSMD (non-solder mask defined) type.

For best results during assembly, alignment ordinals on the PC board may be used to facilitate placement of the micro SMD device.

## micro SMD LIGHT SENSITIVITY

Exposing the micro SMD device to direct sunlight will cause mis-operation of the device. Light sources such as halogen lamps can effect electrical performance if brought near to the device.

The wavelengths which have most detrimental effect are reds and infra-reds, which means that the fluorescent lighting used inside most buildings has very little effect on performance. A micro SMD test board was brought to within 1cm of a fluorescent desk lamp and the effect on the regulated output voltage was negligible, showing a deviation of less than 0.1% from nominal.

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LP3985IM5-2.5	ACTIVE	SOT-23	DBV	5	1000	TBD	CU SNPB	Level-1-260C-UNLIM	-40 to 125	LCSB	<a href="#">Samples</a>
LP3985IM5-2.5/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LCSB	<a href="#">Samples</a>
LP3985IM5-2.7	ACTIVE	SOT-23	DBV	5	1000	TBD	CU SNPB	Level-1-260C-UNLIM	-40 to 125	LCUB	<a href="#">Samples</a>
LP3985IM5-2.7/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LCUB	<a href="#">Samples</a>
LP3985IM5-2.8	ACTIVE	SOT-23	DBV	5	1000	TBD	CU SNPB	Level-1-260C-UNLIM	-40 to 125	LCJB	<a href="#">Samples</a>
LP3985IM5-2.8/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LCJB	<a href="#">Samples</a>
LP3985IM5-2.9/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LCYB	<a href="#">Samples</a>
LP3985IM5-3.0	ACTIVE	SOT-23	DBV	5	1000	TBD	CU SNPB	Level-1-260C-UNLIM	-40 to 125	LCRB	<a href="#">Samples</a>
LP3985IM5-3.0/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LCRB	<a href="#">Samples</a>
LP3985IM5-3.2	ACTIVE	SOT-23	DBV	5	1000	TBD	CU SNPB	Level-1-260C-UNLIM	-40 to 125	LDPB	<a href="#">Samples</a>
LP3985IM5-3.2/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LDPB	<a href="#">Samples</a>
LP3985IM5-3.3	ACTIVE	SOT-23	DBV	5	1000	TBD	CU SNPB	Level-1-260C-UNLIM	-40 to 125	LDQB	<a href="#">Samples</a>
LP3985IM5-3.3/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LDQB	<a href="#">Samples</a>
LP3985IM5-4.7	ACTIVE	SOT-23	DBV	5	1000	TBD	CU SNPB	Level-1-260C-UNLIM	-40 to 125	LDRB	<a href="#">Samples</a>
LP3985IM5-4.7/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LDRB	<a href="#">Samples</a>
LP3985IM5-5.0	ACTIVE	SOT-23	DBV	5	1000	TBD	CU SNPB	Level-1-260C-UNLIM	-40 to 125	LDSB	<a href="#">Samples</a>
LP3985IM5-5.0/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LDSB	<a href="#">Samples</a>
LP3985IM5X-2.5	ACTIVE	SOT-23	DBV	5	3000	TBD	CU SNPB	Level-1-260C-UNLIM	-40 to 125	LCSB	<a href="#">Samples</a>

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LP3985IM5X-2.5/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LCSB	<a href="#">Samples</a>
LP3985IM5X-2.8	ACTIVE	SOT-23	DBV	5	3000	TBD	CU SNPB	Level-1-260C-UNLIM	-40 to 125	LCJB	<a href="#">Samples</a>
LP3985IM5X-2.8/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LCJB	<a href="#">Samples</a>
LP3985IM5X-285	ACTIVE	SOT-23	DBV	5	3000	TBD	CU SNPB	Level-1-260C-UNLIM	-40 to 125	LCXB	<a href="#">Samples</a>
LP3985IM5X-285/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LCXB	<a href="#">Samples</a>
LP3985IM5X-3.0	ACTIVE	SOT-23	DBV	5	3000	TBD	CU SNPB	Level-1-260C-UNLIM	-40 to 125	LCRB	<a href="#">Samples</a>
LP3985IM5X-3.0/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LCRB	<a href="#">Samples</a>
LP3985IM5X-3.3	ACTIVE	SOT-23	DBV	5	3000	TBD	CU SNPB	Level-1-260C-UNLIM	-40 to 125	LDQB	<a href="#">Samples</a>
LP3985IM5X-3.3/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LDQB	<a href="#">Samples</a>
LP3985IM5X-4.7	ACTIVE	SOT-23	DBV	5	3000	TBD	CU SNPB	Level-1-260C-UNLIM	-40 to 125	LDRB	<a href="#">Samples</a>
LP3985IM5X-4.7/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LDRB	<a href="#">Samples</a>
LP3985IM5X-5.0	ACTIVE	SOT-23	DBV	5	3000	TBD	CU SNPB	Level-1-260C-UNLIM	-40 to 125	LDSB	<a href="#">Samples</a>
LP3985IM5X-5.0/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LDSB	<a href="#">Samples</a>
LP3985ITL-2.5/NOPB	ACTIVE	DSBGA	YZR	5	250	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITL-2.6/NOPB	ACTIVE	DSBGA	YZR	5	250	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITL-2.7/NOPB	ACTIVE	DSBGA	YZR	5	250	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITL-2.8/NOPB	ACTIVE	DSBGA	YZR	5	250	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITL-2.9/NOPB	ACTIVE	DSBGA	YZR	5	250	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITL-285/NOPB	ACTIVE	DSBGA	YZR	5	250	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LP3985ITL-3.0/NOPB	ACTIVE	DSBGA	YZR	5	250	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITL-3.1/NOPB	ACTIVE	DSBGA	YZR	5	250	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITL-3.2/NOPB	ACTIVE	DSBGA	YZR	5	250	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITL-3.3/NOPB	ACTIVE	DSBGA	YZR	5	250	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITL-4.75/NOPB	ACTIVE	DSBGA	YZR	5	250	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITL-4.8/NOPB	ACTIVE	DSBGA	YZR	5	250	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM		5	<a href="#">Samples</a>
LP3985ITL-5.0/NOPB	ACTIVE	DSBGA	YZR	5	250	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITLX-2.5/NOPB	ACTIVE	DSBGA	YZR	5	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITLX-2.6/NOPB	ACTIVE	DSBGA	YZR	5	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITLX-2.7/NOPB	ACTIVE	DSBGA	YZR	5	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITLX-2.8/NOPB	ACTIVE	DSBGA	YZR	5	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITLX-2.9/NOPB	ACTIVE	DSBGA	YZR	5	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITLX-285/NOPB	ACTIVE	DSBGA	YZR	5	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITLX-3.0/NOPB	ACTIVE	DSBGA	YZR	5	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITLX-3.1/NOPB	ACTIVE	DSBGA	YZR	5	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITLX-3.2/NOPB	ACTIVE	DSBGA	YZR	5	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITLX-3.3/NOPB	ACTIVE	DSBGA	YZR	5	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>
LP3985ITLX-4.75/NOPB	ACTIVE	DSBGA	YZR	5	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>



Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LP3985ITLX-4.8/NOPB	ACTIVE	DSBGA	YZR	5	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM		5	<a href="#">Samples</a>
LP3985ITLX-5.0/NOPB	ACTIVE	DSBGA	YZR	5	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 125	5	<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

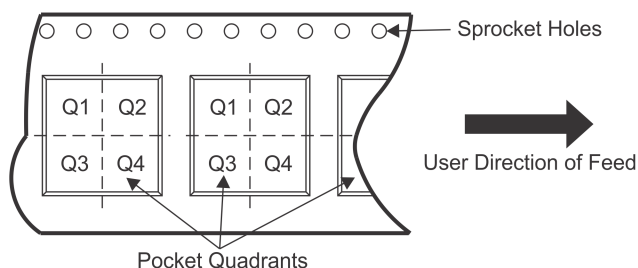
(4) Only one of markings shown within the brackets will appear on the physical device.

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**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LP3985IM5-2.5	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5-2.5/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5-2.7	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5-2.7/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5-2.8	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5-2.8/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5-2.9/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5-3.0	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5-3.0/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5-3.2	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5-3.2/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5-3.3	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5-3.3/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5-4.7	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5-4.7/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5-5.0	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5-5.0/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5X-2.5	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LP3985IM5X-2.5/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5X-2.8	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5X-2.8/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5X-285	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5X-285/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5X-3.0	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5X-3.0/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5X-3.3	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5X-3.3/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5X-4.7	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5X-4.7/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5X-5.0	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985IM5X-5.0/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LP3985ITL-2.5/NOPB	DSBGA	YZR	5	250	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITL-2.6/NOPB	DSBGA	YZR	5	250	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITL-2.7/NOPB	DSBGA	YZR	5	250	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITL-2.8/NOPB	DSBGA	YZR	5	250	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITL-2.9/NOPB	DSBGA	YZR	5	250	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITL-285/NOPB	DSBGA	YZR	5	250	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITL-3.0/NOPB	DSBGA	YZR	5	250	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITL-3.1/NOPB	DSBGA	YZR	5	250	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITL-3.2/NOPB	DSBGA	YZR	5	250	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITL-3.3/NOPB	DSBGA	YZR	5	250	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITL-4.75/NOPB	DSBGA	YZR	5	250	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITL-4.8/NOPB	DSBGA	YZR	5	250	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITL-5.0/NOPB	DSBGA	YZR	5	250	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITLX-2.5/NOPB	DSBGA	YZR	5	3000	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITLX-2.6/NOPB	DSBGA	YZR	5	3000	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITLX-2.7/NOPB	DSBGA	YZR	5	3000	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITLX-2.8/NOPB	DSBGA	YZR	5	3000	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITLX-2.9/NOPB	DSBGA	YZR	5	3000	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITLX-285/NOPB	DSBGA	YZR	5	3000	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITLX-3.0/NOPB	DSBGA	YZR	5	3000	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITLX-3.1/NOPB	DSBGA	YZR	5	3000	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITLX-3.2/NOPB	DSBGA	YZR	5	3000	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITLX-3.3/NOPB	DSBGA	YZR	5	3000	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITLX-4.75/NOPB	DSBGA	YZR	5	3000	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITLX-4.8/NOPB	DSBGA	YZR	5	3000	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1
LP3985ITLX-5.0/NOPB	DSBGA	YZR	5	3000	178.0	8.4	1.09	1.55	0.76	4.0	8.0	Q1

## TAPE AND REEL BOX DIMENSIONS



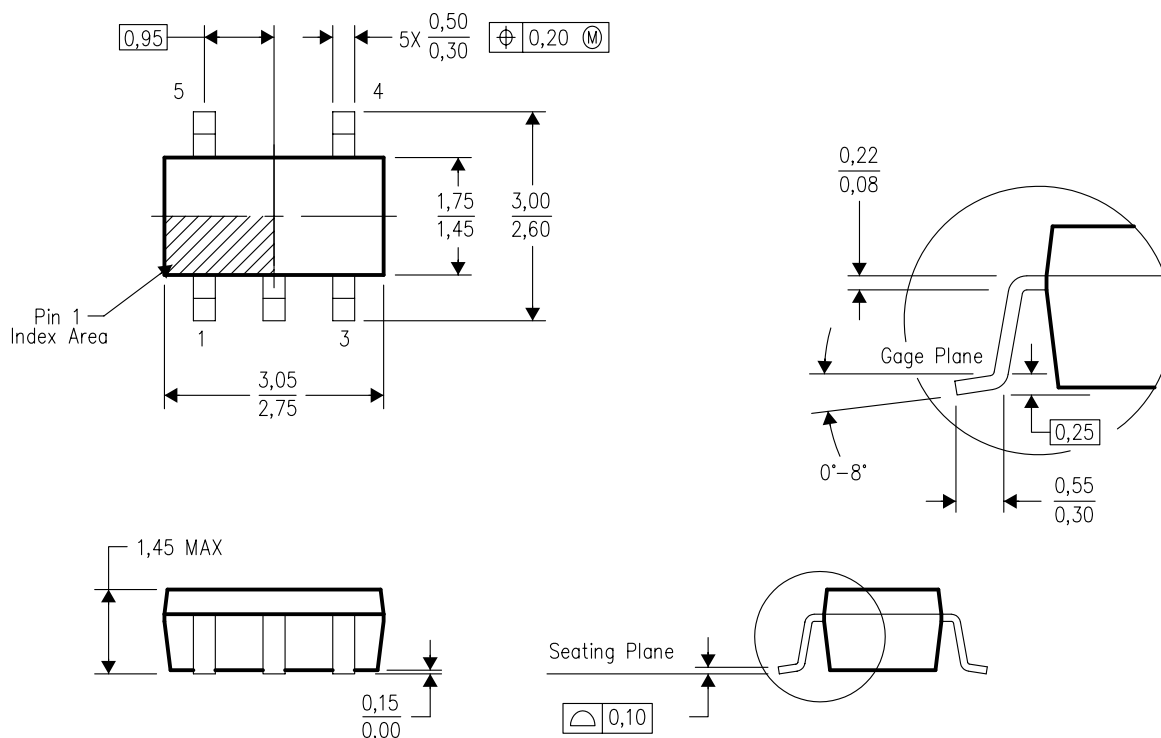
\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LP3985IM5-2.5	SOT-23	DBV	5	1000	203.0	190.0	41.0
LP3985IM5-2.5/NOPB	SOT-23	DBV	5	1000	203.0	190.0	41.0
LP3985IM5-2.7	SOT-23	DBV	5	1000	203.0	190.0	41.0
LP3985IM5-2.7/NOPB	SOT-23	DBV	5	1000	203.0	190.0	41.0
LP3985IM5-2.8	SOT-23	DBV	5	1000	203.0	190.0	41.0
LP3985IM5-2.8/NOPB	SOT-23	DBV	5	1000	203.0	190.0	41.0
LP3985IM5-2.9/NOPB	SOT-23	DBV	5	1000	203.0	190.0	41.0
LP3985IM5-3.0	SOT-23	DBV	5	1000	203.0	190.0	41.0
LP3985IM5-3.0/NOPB	SOT-23	DBV	5	1000	203.0	190.0	41.0
LP3985IM5-3.2	SOT-23	DBV	5	1000	203.0	190.0	41.0
LP3985IM5-3.2/NOPB	SOT-23	DBV	5	1000	203.0	190.0	41.0
LP3985IM5-3.3	SOT-23	DBV	5	1000	203.0	190.0	41.0
LP3985IM5-3.3/NOPB	SOT-23	DBV	5	1000	203.0	190.0	41.0
LP3985IM5-4.7	SOT-23	DBV	5	1000	203.0	190.0	41.0
LP3985IM5-4.7/NOPB	SOT-23	DBV	5	1000	203.0	190.0	41.0
LP3985IM5-5.0	SOT-23	DBV	5	1000	203.0	190.0	41.0
LP3985IM5-5.0/NOPB	SOT-23	DBV	5	1000	203.0	190.0	41.0
LP3985IM5X-2.5	SOT-23	DBV	5	3000	206.0	191.0	90.0
LP3985IM5X-2.5/NOPB	SOT-23	DBV	5	3000	206.0	191.0	90.0
LP3985IM5X-2.8	SOT-23	DBV	5	3000	206.0	191.0	90.0

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LP3985IM5X-2.8/NOPB	SOT-23	DBV	5	3000	206.0	191.0	90.0
LP3985IM5X-285	SOT-23	DBV	5	3000	206.0	191.0	90.0
LP3985IM5X-285/NOPB	SOT-23	DBV	5	3000	206.0	191.0	90.0
LP3985IM5X-3.0	SOT-23	DBV	5	3000	206.0	191.0	90.0
LP3985IM5X-3.0/NOPB	SOT-23	DBV	5	3000	206.0	191.0	90.0
LP3985IM5X-3.3	SOT-23	DBV	5	3000	206.0	191.0	90.0
LP3985IM5X-3.3/NOPB	SOT-23	DBV	5	3000	206.0	191.0	90.0
LP3985IM5X-4.7	SOT-23	DBV	5	3000	206.0	191.0	90.0
LP3985IM5X-4.7/NOPB	SOT-23	DBV	5	3000	206.0	191.0	90.0
LP3985IM5X-5.0	SOT-23	DBV	5	3000	206.0	191.0	90.0
LP3985IM5X-5.0/NOPB	SOT-23	DBV	5	3000	206.0	191.0	90.0
LP3985ITL-2.5/NOPB	DSBGA	YZR	5	250	203.0	190.0	41.0
LP3985ITL-2.6/NOPB	DSBGA	YZR	5	250	203.0	190.0	41.0
LP3985ITL-2.7/NOPB	DSBGA	YZR	5	250	203.0	190.0	41.0
LP3985ITL-2.8/NOPB	DSBGA	YZR	5	250	203.0	190.0	41.0
LP3985ITL-2.9/NOPB	DSBGA	YZR	5	250	203.0	190.0	41.0
LP3985ITL-285/NOPB	DSBGA	YZR	5	250	203.0	190.0	41.0
LP3985ITL-3.0/NOPB	DSBGA	YZR	5	250	203.0	190.0	41.0
LP3985ITL-3.1/NOPB	DSBGA	YZR	5	250	203.0	190.0	41.0
LP3985ITL-3.2/NOPB	DSBGA	YZR	5	250	203.0	190.0	41.0
LP3985ITL-3.3/NOPB	DSBGA	YZR	5	250	203.0	190.0	41.0
LP3985ITL-4.75/NOPB	DSBGA	YZR	5	250	203.0	190.0	41.0
LP3985ITL-4.8/NOPB	DSBGA	YZR	5	250	203.0	190.0	41.0
LP3985ITL-5.0/NOPB	DSBGA	YZR	5	250	203.0	190.0	41.0
LP3985ITLX-2.5/NOPB	DSBGA	YZR	5	3000	206.0	191.0	90.0
LP3985ITLX-2.6/NOPB	DSBGA	YZR	5	3000	206.0	191.0	90.0
LP3985ITLX-2.7/NOPB	DSBGA	YZR	5	3000	206.0	191.0	90.0
LP3985ITLX-2.8/NOPB	DSBGA	YZR	5	3000	206.0	191.0	90.0
LP3985ITLX-2.9/NOPB	DSBGA	YZR	5	3000	206.0	191.0	90.0
LP3985ITLX-285/NOPB	DSBGA	YZR	5	3000	206.0	191.0	90.0
LP3985ITLX-3.0/NOPB	DSBGA	YZR	5	3000	206.0	191.0	90.0
LP3985ITLX-3.1/NOPB	DSBGA	YZR	5	3000	206.0	191.0	90.0
LP3985ITLX-3.2/NOPB	DSBGA	YZR	5	3000	206.0	191.0	90.0
LP3985ITLX-3.3/NOPB	DSBGA	YZR	5	3000	206.0	191.0	90.0
LP3985ITLX-4.75/NOPB	DSBGA	YZR	5	3000	206.0	191.0	90.0
LP3985ITLX-4.8/NOPB	DSBGA	YZR	5	3000	206.0	191.0	90.0
LP3985ITLX-5.0/NOPB	DSBGA	YZR	5	3000	206.0	191.0	90.0

## DBV (R-PDSO-G5)

## PLASTIC SMALL-OUTLINE PACKAGE



4073253-4/K 03/2006

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - D. Falls within JEDEC MO-178 Variation AA.

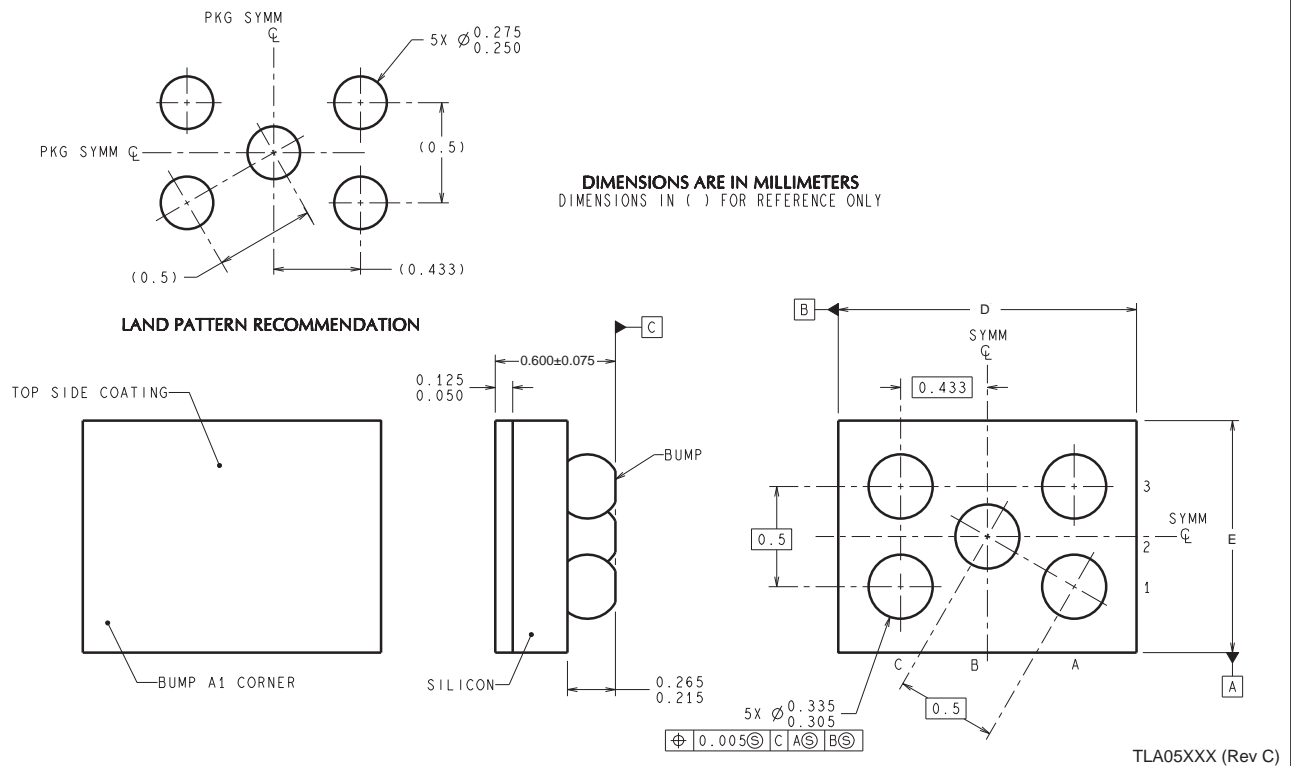
DBV (R-PDSO-G5)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
  - D. Publication IPC-7351 is recommended for alternate designs.
  - E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.

YZR0005



D: Max = 1.522 mm, Min = 1.421 mm

E: Max = 1.065 mm, Min = 0.964 mm

4215043/A 12/12

NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.  
B. This drawing is subject to change without notice.

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